

An abstract graphic on the left side of the image, composed of numerous thin, wavy green lines that swirl and overlap to form a complex, organic shape. The lines are a vibrant green color against the dark blue background.

# Open. Together.

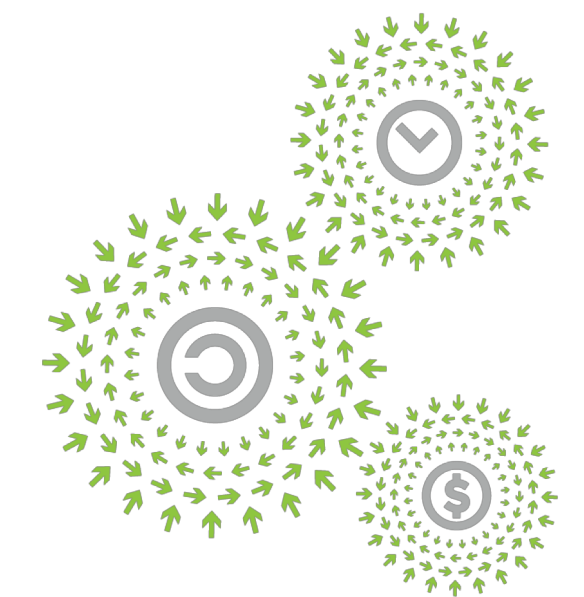


**OCP**  
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# ACS Door Heat Exchanger Concepts/Specification Update

John Fernandes, Thermal Engineer, Facebook



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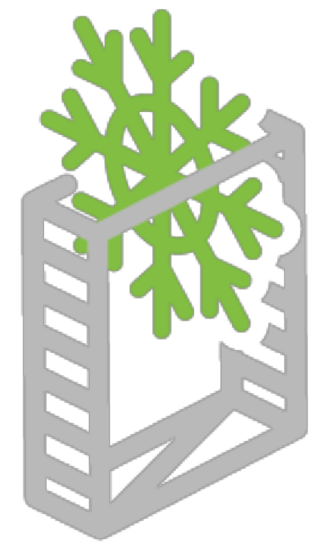
# Overview of ACS Sub-Project

**Goal:** Enabling advanced cooling in Open Rack and EIA310 architectures

Standardization/definition of

- Critical interfaces
- Operational parameters
- Environmental conditions

Enable a non-proprietary, multi-vendor supply chain of cooling solutions



ACS



Specifications

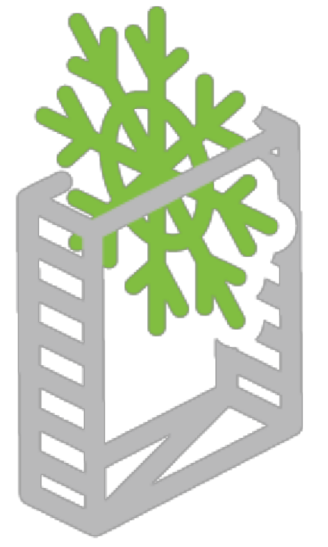


# Work Streams in ACS

## Cooling architectures scoped

- Cold plate
- Immersion
- Door Heat Exchanger

Architecture harmonization: Consistency, materials, DC interfaces, etc.



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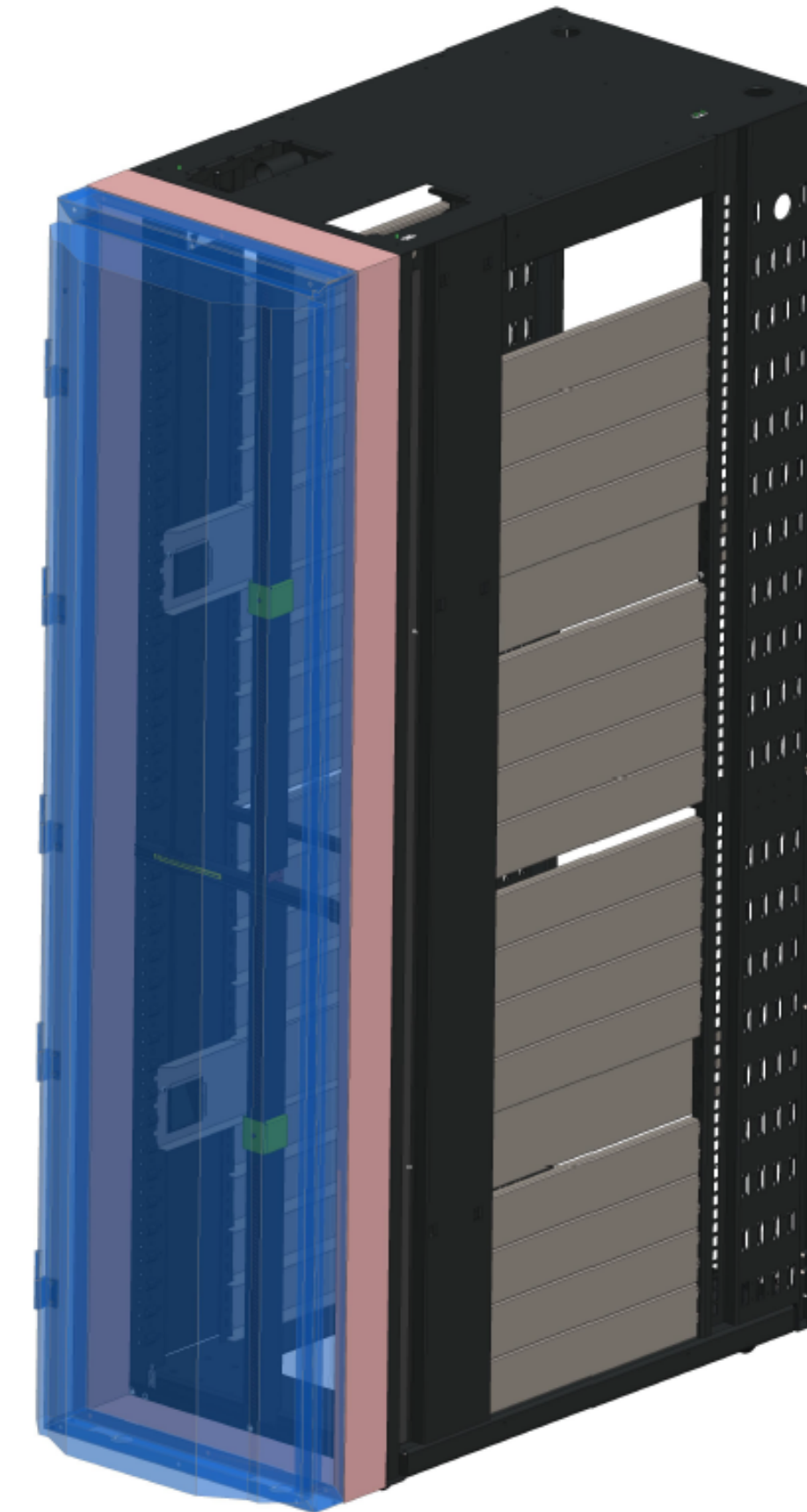
Specifications



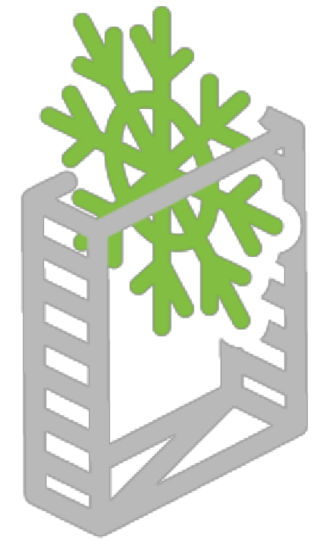
# Door HX Work Stream

## In-scope activities

- Fluid physical properties and types
- Operating conditions and parameters
- Metrology of heat extraction performance
- Definition of different solutions
  - Data centers equipped with facility water
  - Data centers employing free-air cooling only



*Door HX mounted to ORv2*



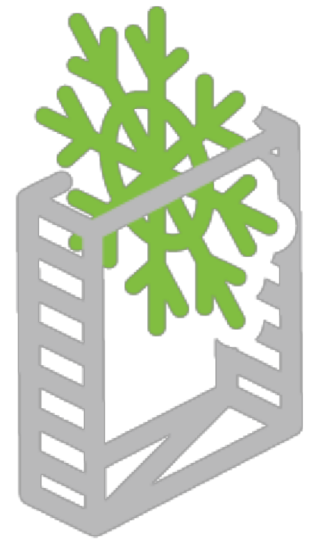
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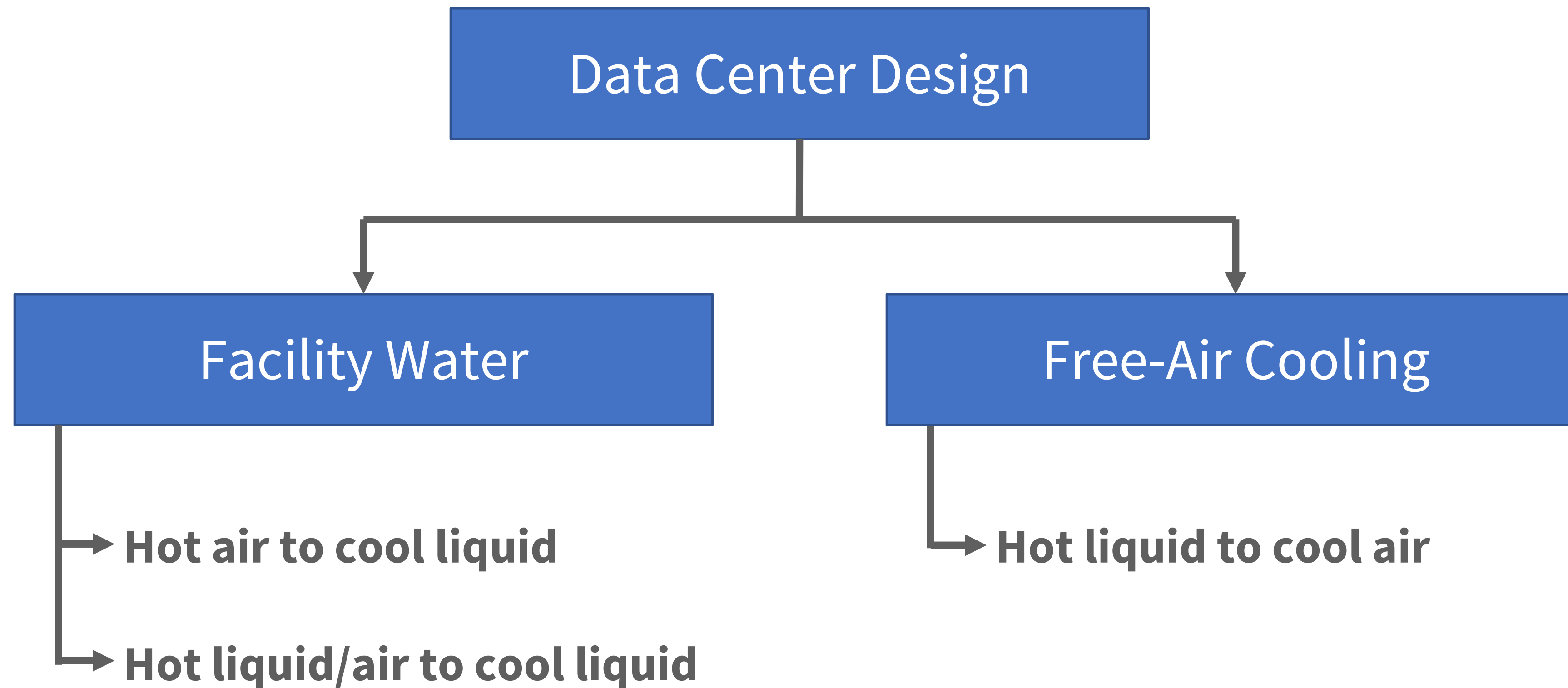
Specifications



# Overview of Solutions



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# Overview of Solutions

Data Center Design

Facility Water

Hot air to cool liquid

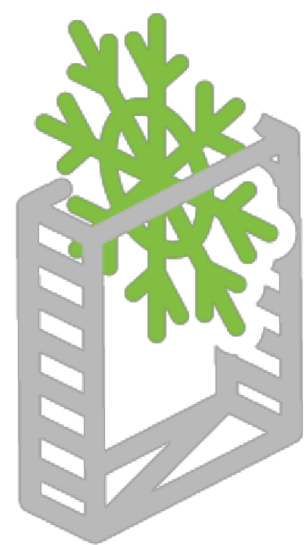
Hot liquid/air to cool liquid

Air

IT Gear

Door HX

Facility-side liquid connections

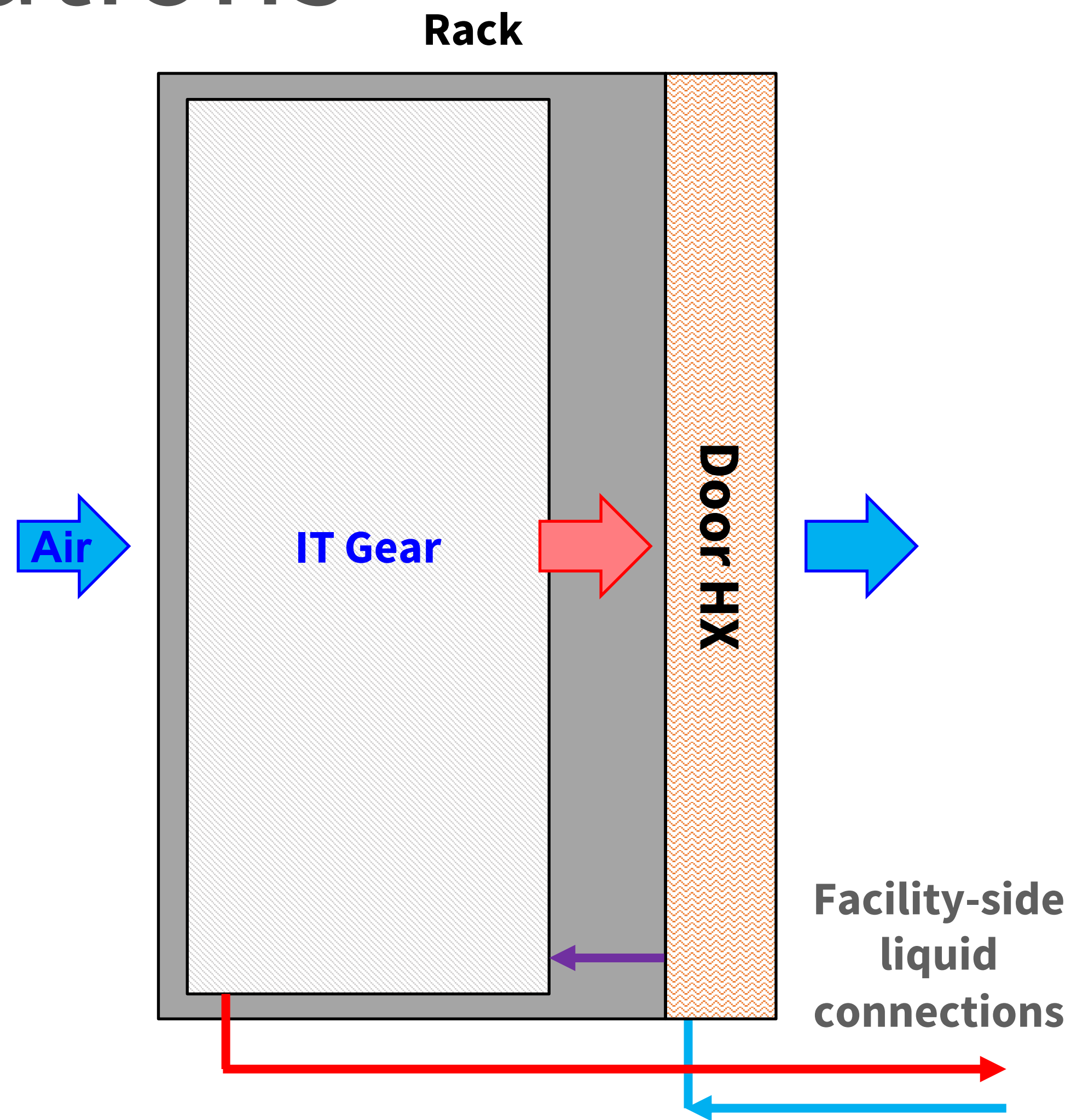
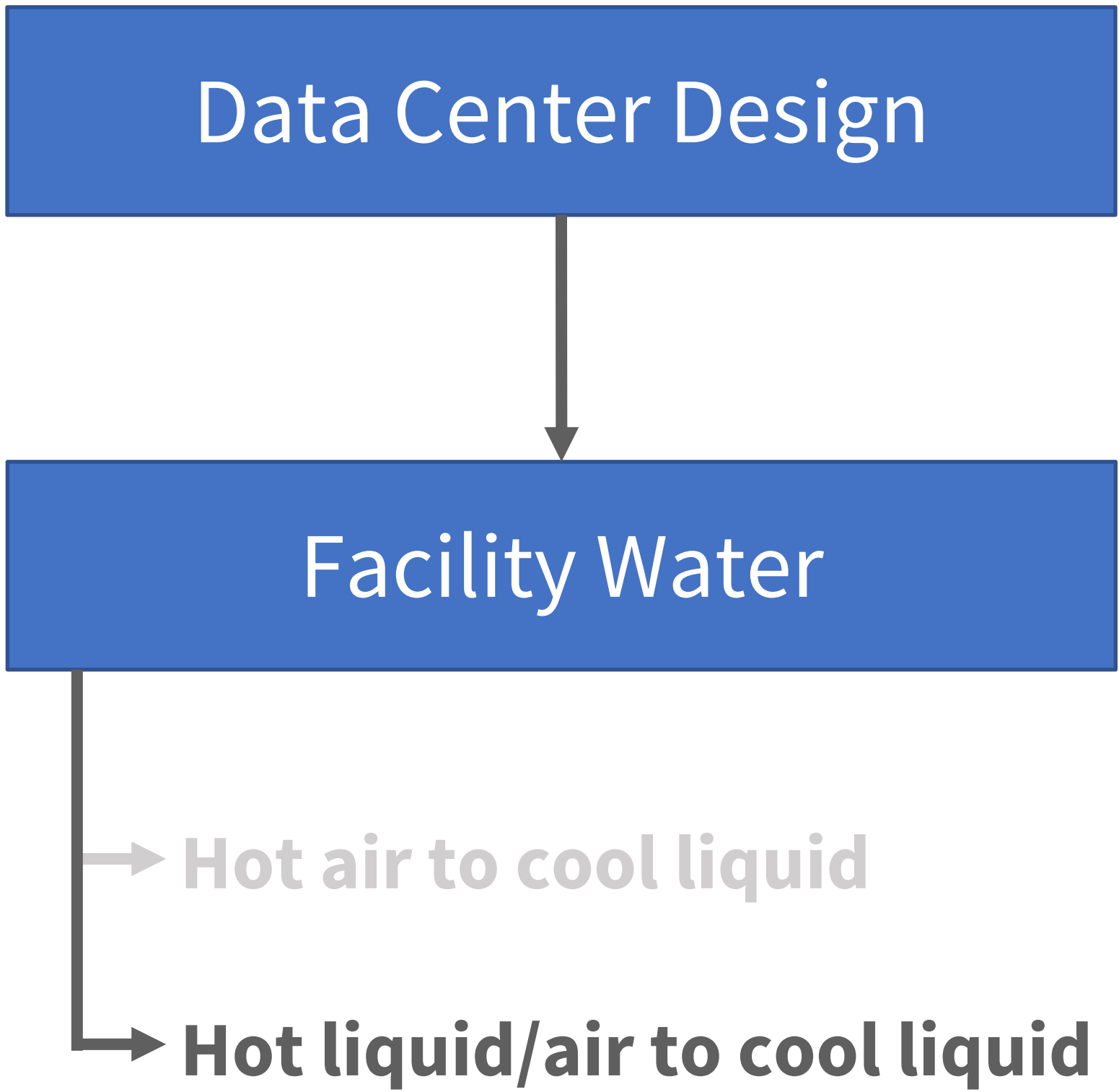


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# Overview of Solutions



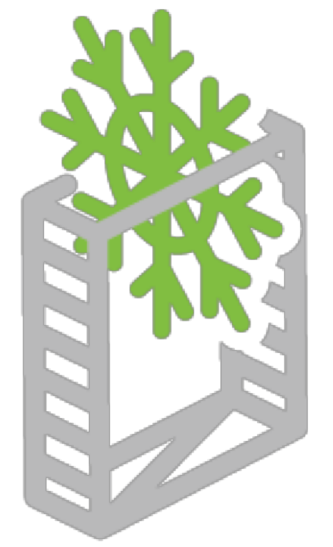
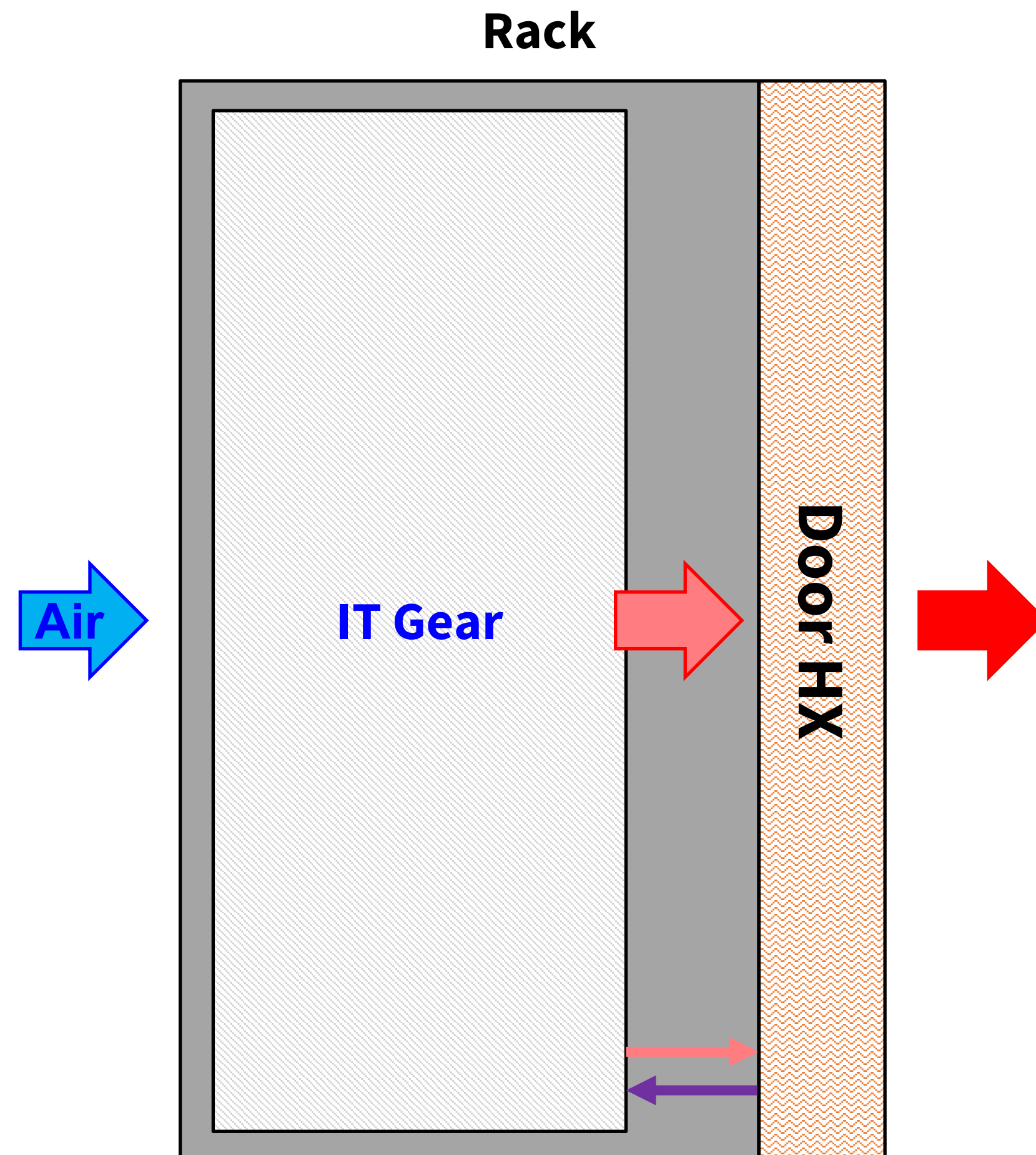
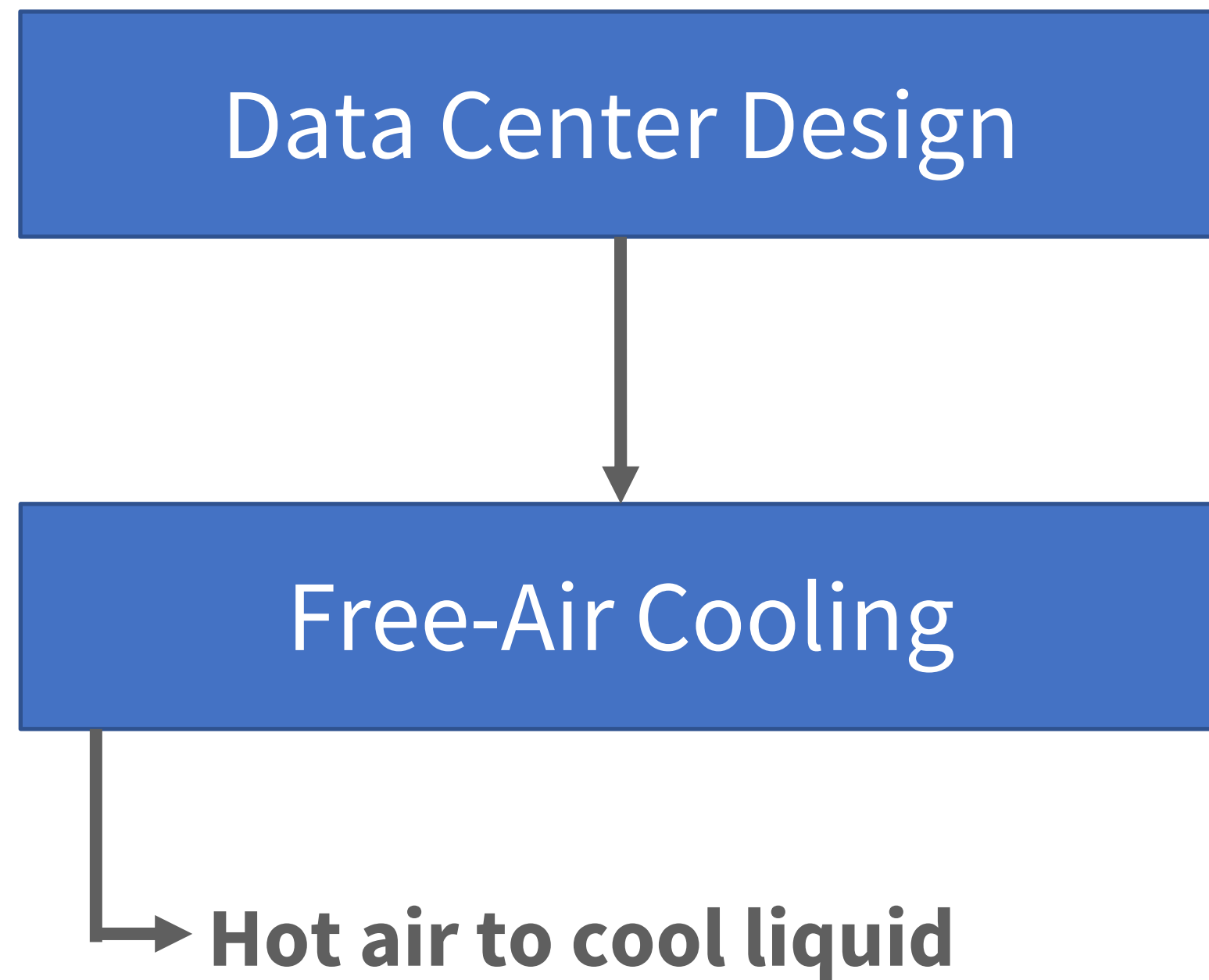
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# Overview of Solutions



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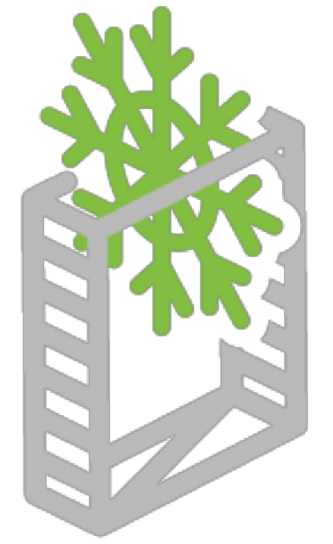


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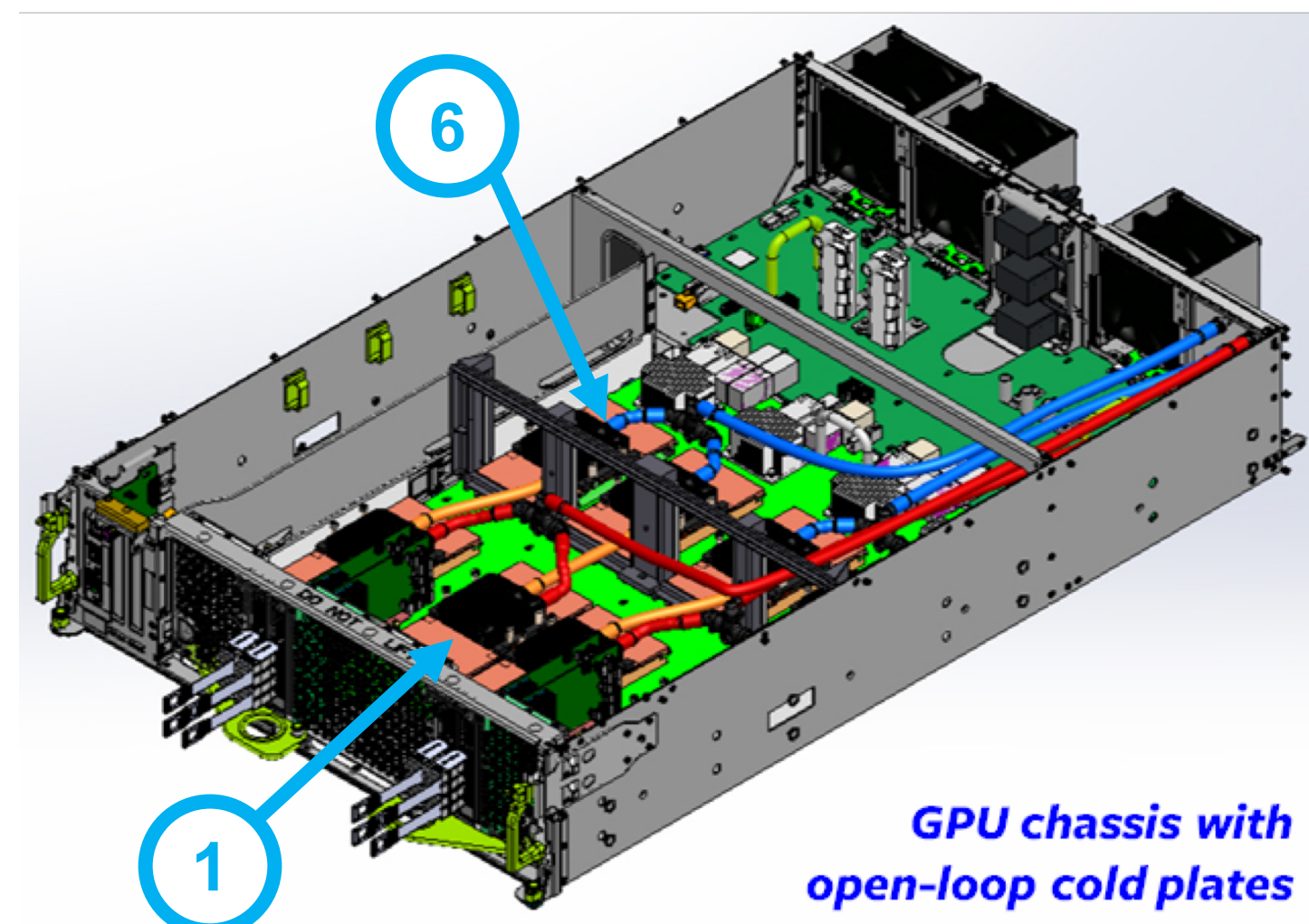


# Hybrid: Closed-Loop

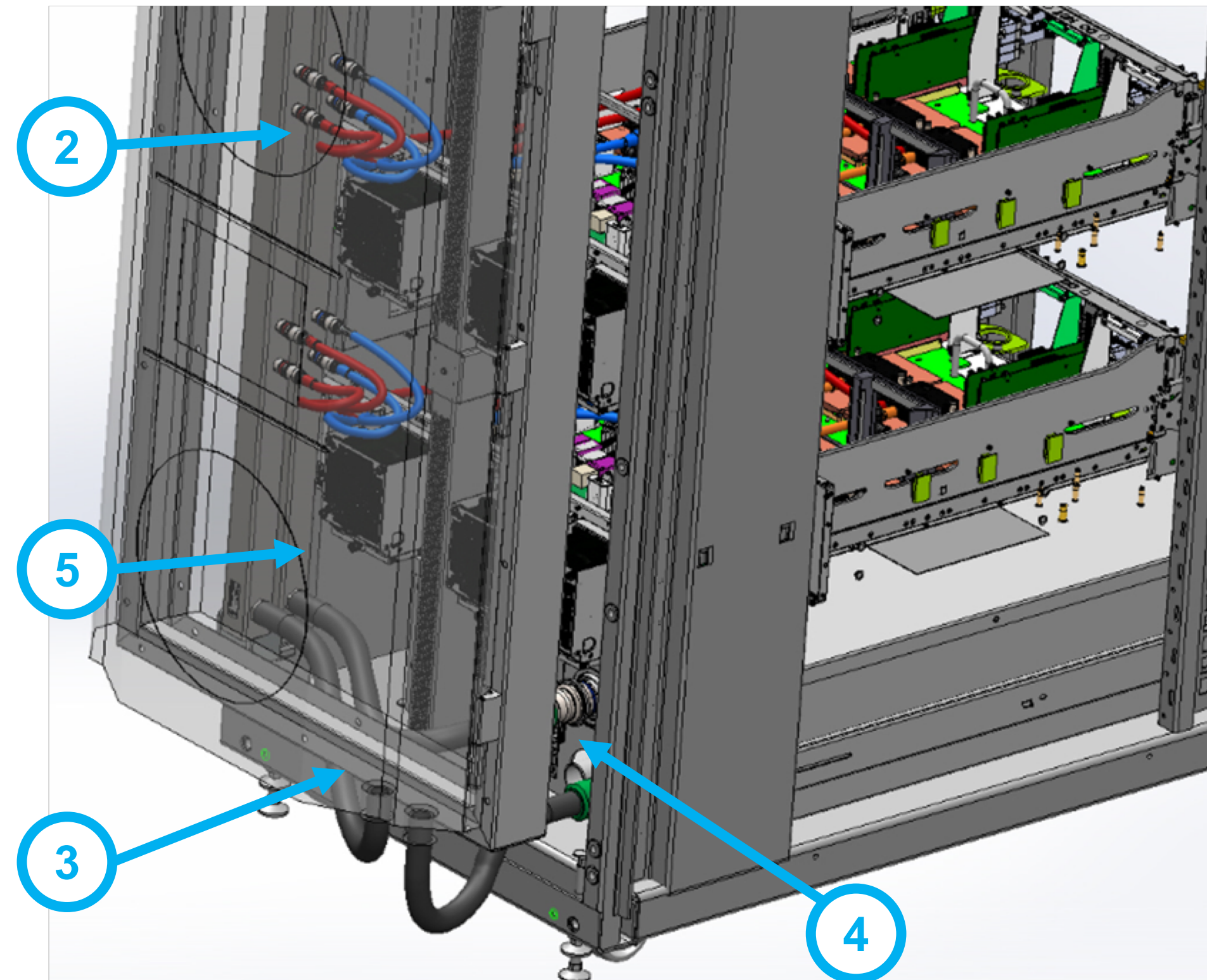
Cold plate → Hot manifold → Door Hx → CDU → Cold Manifold → Cold plate...



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GPU chassis with open-loop cold plates



Connections between manifolds, Door Hx and CDU



Specifications



# Specification

Physical

DC Environment

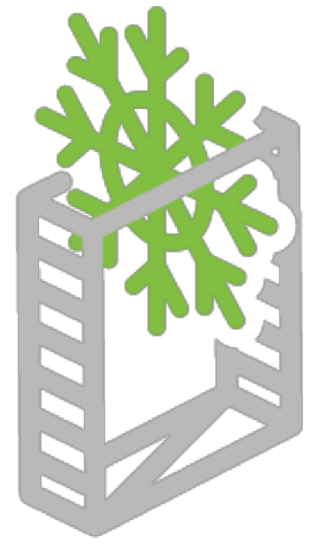
Performance / Metrology

Monitoring & Control

Serviceability

Reliability & Quality

Environmental & Regulations

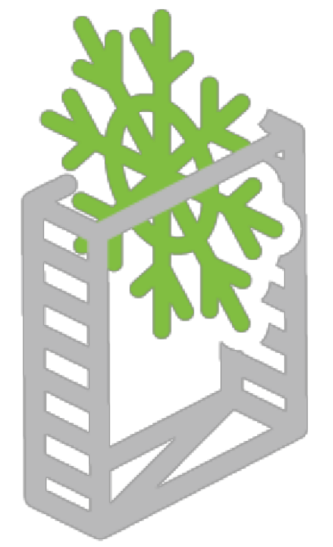


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Specifications

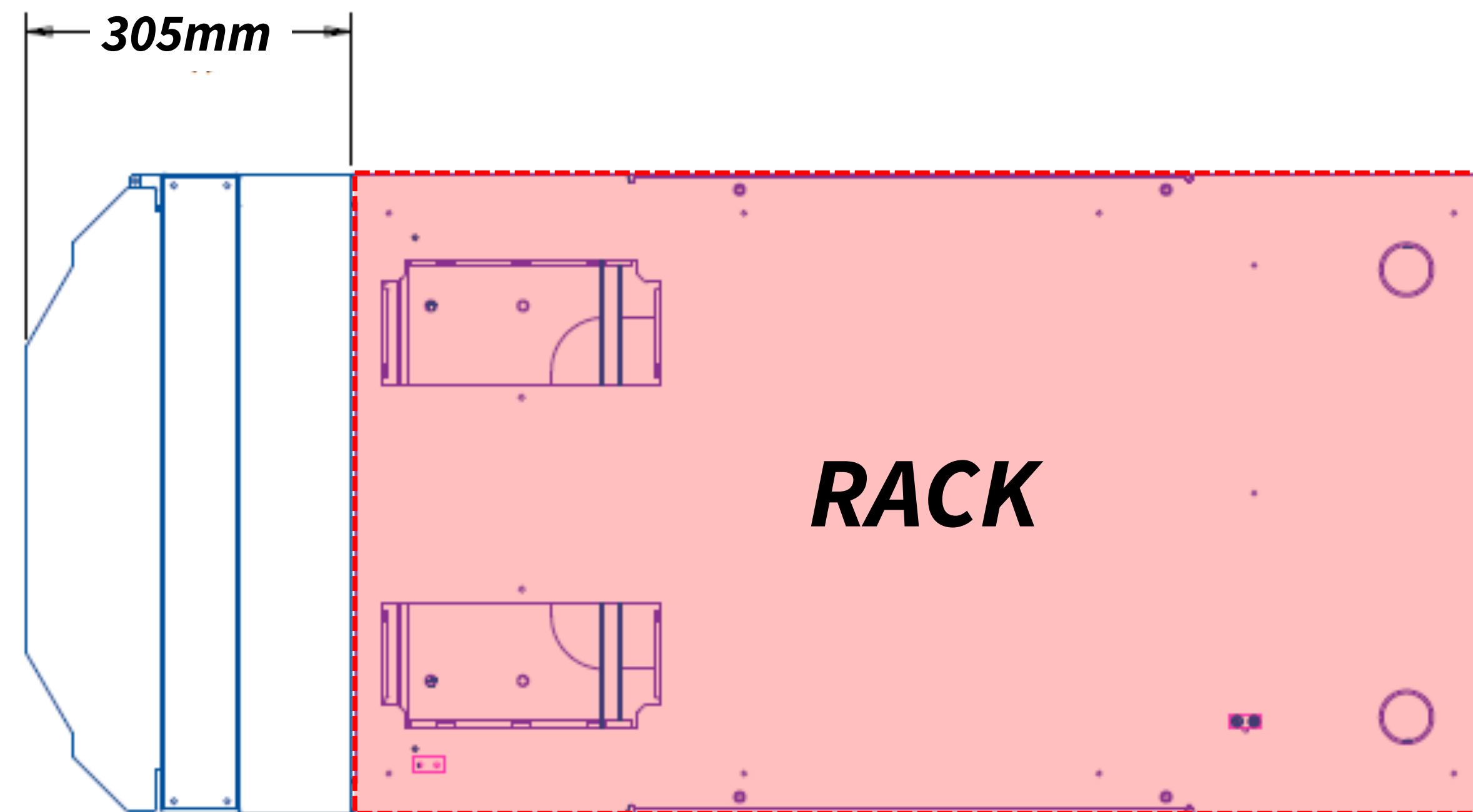
# Specification



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Physical

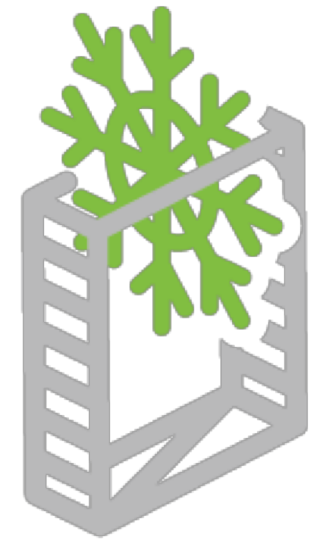
- Width and height must be within rack's primary structure/frame
- Maximum depth of 305mm (1ft); both active and passive versions



Specifications



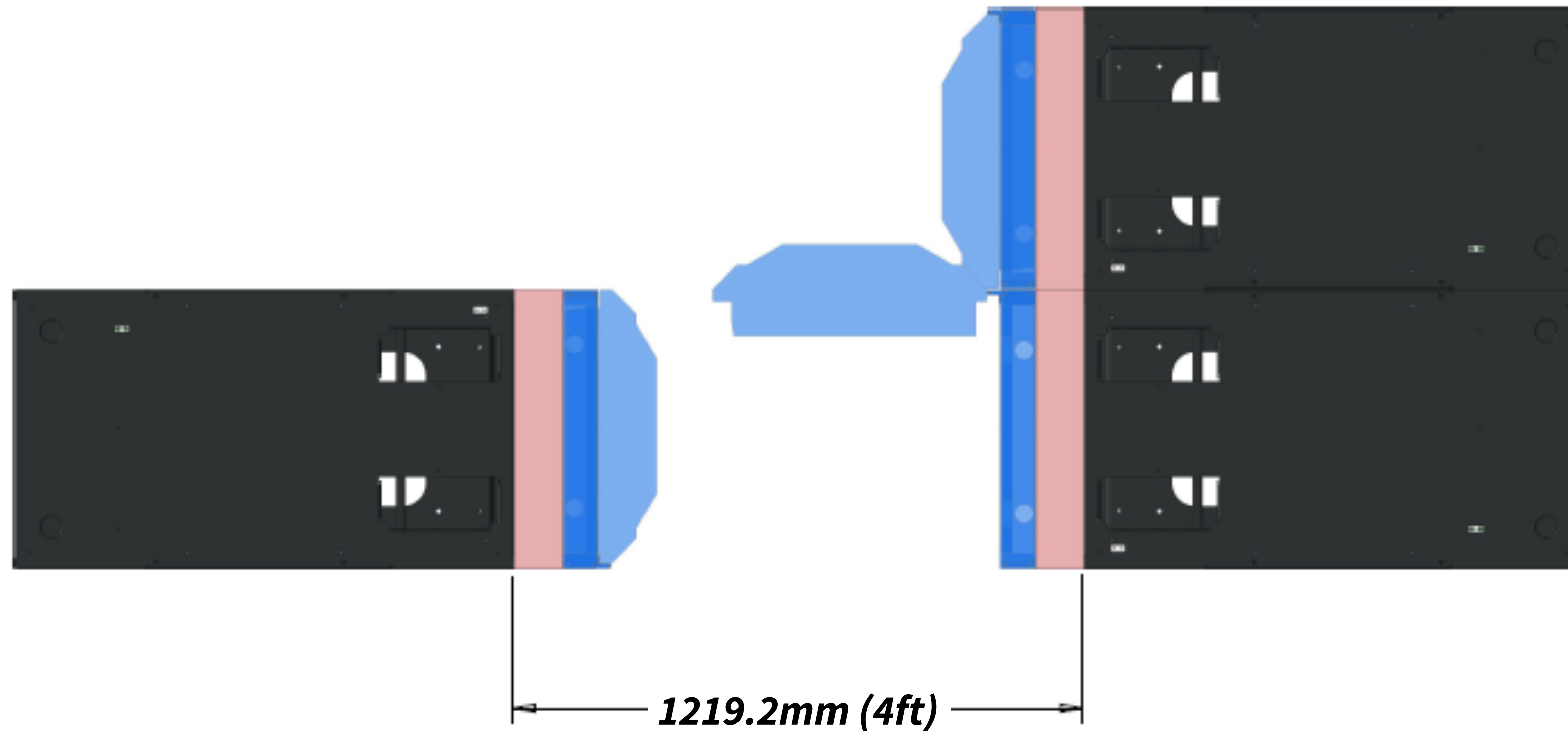
# Specification



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Physical

- Hinged solution should permit opening of door by 90°



Specifications

# Specification



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- Air-side conditions

Cold-aisle Temperature	18°C ~ 35°C (65°F ~ 85°F)
Temperature Ramp Rate	5°C/15min
Cold-aisle Pressurization	0.005" H <sub>2</sub> O (1.24Pa)
Relative Humidity	10% ~ 90%
Altitude	≤ 2000m (6600ft)
Temperature Difference *	≥ 12.2°C (22°F)

\* or dependent on IT gear being supported; 12.2°C may serve as a reference value to define performance metrics under 100% neutralization of heat load



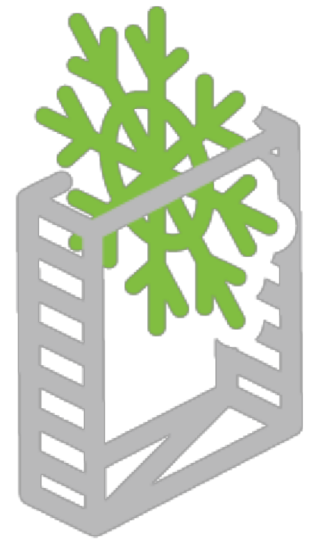
Specifications



# Specification

## Performance / Metrology

- For active variant, N+1 rotor redundancy is a must
- Face area of heat exchanger within supporting frame should be maximized for performance and minimal back-pressure
- Performance curves for effective sizing of solution to IT gear and rack requirements
- Low air-side pressure drop to minimize impact to server fans
- For active variant, total power consumption should be  $\leq 2\%$  of rated heat rejection capacity
- De-rating factor(s) for heat rejection capacity based on
  - Coolant selection (with respect to water)
  - Altitude (with respect to sea-level operation)



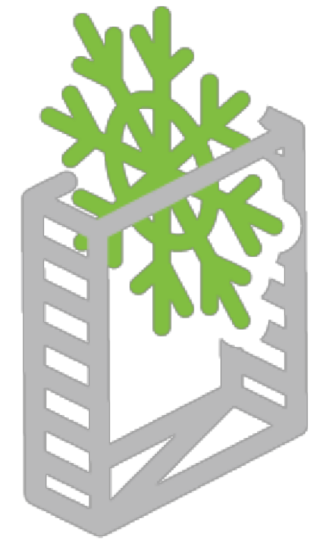
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Specifications

# Need for Harmonization

Some areas are common across work streams



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Align with or leverage in-scope activities from cold plate

- Interfaces to facilities
- Fluid physical properties and types
- Operating conditions and parameters
- Hot-plug, dripless valves between IT gear and rack

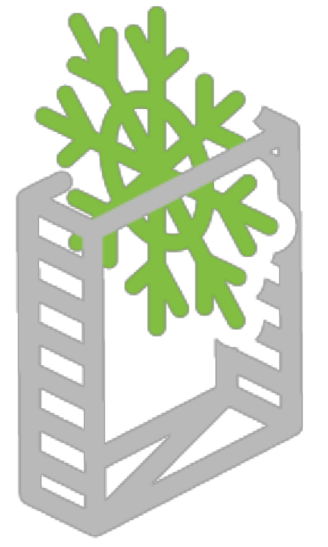


Specifications



# Planned Milestones

- Initialize specification document [2/2019]
- Input from community [On-going]
  - Physical Interfaces
  - Performance / Metrology
  - Serviceability
  - Reliability & Quality
  - Environmental & Regulations
- Formal version by OCP regional summit [9/2019]



ACS



Specifications

# Call to Action

## How to get involved

- Bi-weekly calls: Thursdays at 9am PST
- Next meeting on March 21<sup>st</sup>

## Useful information

Project lead: Jacob Na, Facebook ([jacob.na@ocproject.net](https://www.facebook.com/jacob.na@ocproject.net))

ACS wiki : [https://www.opencompute.org/wiki/Rack\\_%26\\_Power/Advanced\\_Cooling\\_Solutions](https://www.opencompute.org/wiki/Rack_%26_Power/Advanced_Cooling_Solutions)

ACS mailing list: <https://ocp-all.groups.io/g/OCP-ACS>

ACS Door HX mailing list: <https://ocp-all.groups.io/g/OCP-ACS-Door-Heat-Exchange>





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OCP Global Summit | March 14–15, 2019





Physical

